

MSX1PB, MSX1PD, MSX1PG, MSX1PJ

Vishay General Semiconductor

AUTOMOTIVE

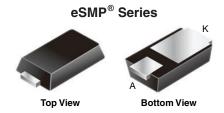
RoHS

COMPLIANT

HALOGEN

FREE

Surface-Mount ESD Capability Rectifier



MicroSMP (DO-219AD)



LINKS TO ADDITIONAL RESOURCES



PRIMARY CHARACTERISTICS				
I _{F(AV)}	1.0 A			
V _{RRM}	100 V, 200 V, 400 V, 600 V			
I _{FSM}	18 A			
V _F at I _F = 1.0 A (125 °C)	0.9 V			
T _J max.	175 °C			
Package	MicroSMP (DO-219AD)			
Circuit configuration	Single			

FEATURES

- Very low profile typical height of 0.65 mm
- · Ideal for automated placement
- · Oxide planar chip junction
- · Low forward voltage drop, low leakage current
- ESD capability
- Meets MSL level J-STD-020. 1, per LF maximum peak of 260 °C
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see www.vishav.com/doc?99912

TYPICAL APPLICATIONS

General purpose, polarity protection, and rail-to-rail protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: MicroSMP (DO-219AD)

Molding compound meets UL 94 V-0 flammability rating Base P/N-M3 - halogen-free and RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS (T _A = 25 °C unless otherwise noted)							
PARAMETER	SYMBOL	MSX1PB	MSX1PD	MSX1PG	MSX1PJ	UNIT	
Device marking code		XB	XD	XG	XJ		
Maximum repetitive peak reverse voltage	V_{RRM}	100	200	400	600	V	
Maximum average forward rectified current	I _{F(AV)}	1.0				Α	
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I _{FSM}	18				Α	
Operating junction and storage temperature range	T _J , T _{STG}	-55 to +175				°C	



MSX1PB, MSX1PD, MSX1PG, MSX1PJ

Vishay General Semiconductor

ELECTRICAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
Maximum instantaneous forward voltage	$I_F = 0.5 A$	T _A = 25 °C T _A = 125 °C	V _F ⁽¹⁾	0.93	-	V
	I _F = 1.0 A			1.0	1.1	
	$I_F = 0.5 A$			0.81	-	
	I _F = 1.0 A			0.9	0.98	
Maximum reverse current	Rated V _R	T _A = 25 °C	I _R ⁽²⁾	-	1.0	μА
Maximum reverse current	nateu v _R	T _A = 125 °C		4.1	50	
Typical reverse recovery time	$I_F = 0.5 \text{ A}, I_R = 1.0 \text{ A}, I_{rr} = 0.25 \text{ A}$		t _{rr}	960	-	ns
Typical junction capacitance	4.0 V, 1 MHz		CJ	5	-	pF

Notes

 $^{(1)}$ Pulse test: 300 μ s pulse width, 1 % duty cycle

(2) Pulse test: pulse width ≤ 40 ms

THERMAL CHARACTERISTICS (T _A = 25 °C unless otherwise noted)						
PARAMETER	SYMBOL	MSX1PB	MSX1PD	MSX1PG	MSX1PJ	UNIT
Typical thermal resistance	R _{0JA} (1)		°C/W			
Typical thermal resistance	R ₀ JL (1)	30				

Note

(1) Thermal resistance from junction to ambient and junction to lead mounted on PCB with 5.0 mm x 5.0 mm copper pad areas. $R_{\theta JL}$ is measured at the terminal of cathode band

IMMUNITY TO ELECTRICAL STATIC DISCHARGE TO THE FOLLOWING STANDARDS ($T_A = 25~^{\circ}\text{C}$, unless otherwise noted)						
STANDARD	TEST TYPE	TEST CONDITIONS	SYMBOL	CLASS	VALUE	
AEC-Q101-001	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ		НЗВ	> 8 kV	
AEC-Q101-002	Machine model (contact mode)	C = 200 pF, R = 0 Ω		M4	> 400 V	
JESD 22-A114	Human body model (contact mode)	C = 100 pF, R = 1.5 kΩ		3B	> 8 kV	
JESD 22-A115	Machine model (contact mode)	C = 200 pF, R = 0 Ω	V_{C}	С	> 400 V	
IEC 61000-4-2 (2) Human body model (contact mode)		C = 150 pF, R = 330 Ω		4	> 8 kV	
1EC 01000-4-2 (=)	Human body model (air-discharge mode) (1)	C = 150 pF, R = 330 Ω		4	> 15 kV	
ISO 10605	Contact mode	$C = 330 \text{ pF}, R = 2 \text{ k}\Omega$		-	20 kV typ.	

Notes

(1) Immunity to IEC 61000-4-2 air discharge mode has a typical performance > 30 kV

(2) System ESD standard

ORDERING INFORMATION (Example)					
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE	
MSX1PJ-M3/89A	0.006	89A	4500	7" diameter plastic tape and reel	
MSX1PJHM3/89A (1)	0.006	89A	4500	7" diameter plastic tape and reel	

Note

(1) AEC-Q101 qualified

www.vishay.com

Vishay General Semiconductor

RATINGS AND CHARACTERISTICS CURVES (T_A = 25 °C unless otherwise noted)

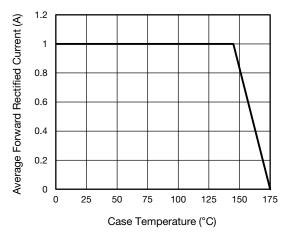


Fig. 1 - Maximum Forward Current Derating Curve

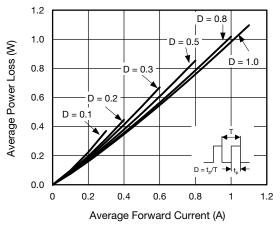


Fig. 2 - Average Power Loss Characteristics

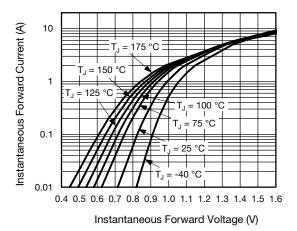


Fig. 3 - Typical Instantaneous Forward Characteristics

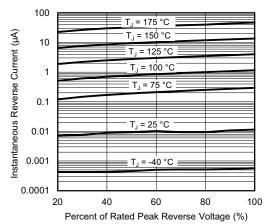


Fig. 4 - Typical Reverse Leakage Characteristics

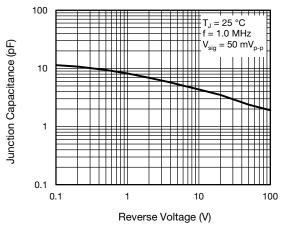


Fig. 5 - Typical Junction Capacitance

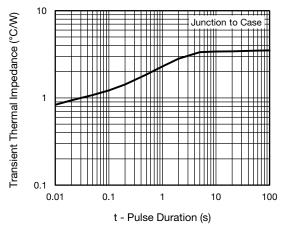


Fig. 6 - Typical Transient Thermal Impedance

Vishay General Semiconductor



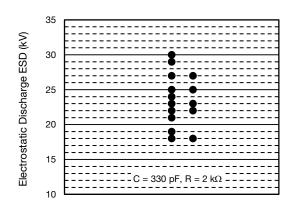
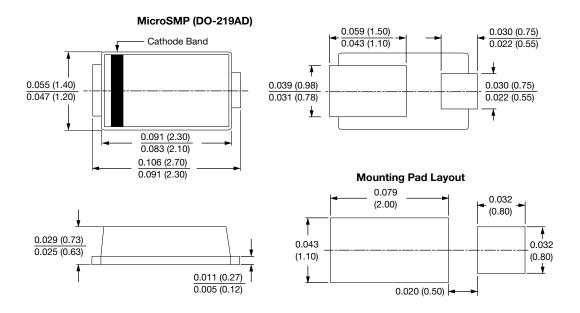


Fig. 7 - ESD Dispersion Map

PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.